



MICROWAVE CORPORATION v00.0906



HMC277MS8 / 277MS8E

**GaAs MMIC SMT SINGLE
BALANCED MIXER, 0.7 - 1.2 GHz**

Typical Applications

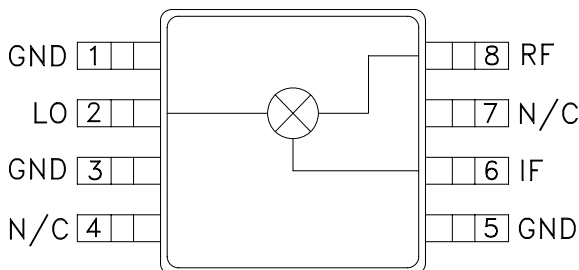
The HMC277MS8 / HMC277MS8E is ideal for:

- Cellular / 3G Infrastructure
- Basestations & Repeaters
- GSM, CDMA & WCDMA
- Subscribers & Portables

Features

- Passive Topology
- LO / RF Isolation: 26 dB
- Input IP3: +21 dBm
- Low Conversion Loss: 9 dB
- RoHS Compliant MSOP-8 Package

Functional Diagram



General Description

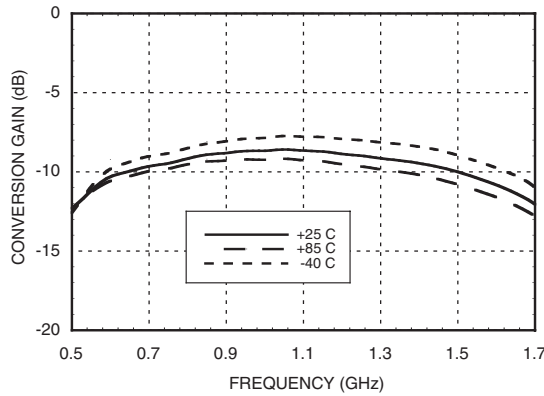
The HMC277MS8 & HMC277MS8E are general purpose single balanced mixers in 8 lead plastic surface mount Mini Small Outline Packages (MSOP). This passive MMIC mixer is constructed of GaAs Schottky diodes and a novel planar transformer balun on the chip. The HMC277MS8(E) requires no external matching components, and is ideal for upconverter and downconverter applications. The RF port is balanced via the MMIC balun while the LO port is connected directly to the diodes. This product is pin for pin compatible with the HMC272MS8(E) which operates from 1.7 to 3.0 GHz.

Electrical Specifications, $T_A = +25^\circ \text{C}$, LO = +13 dBm, IF = 100 MHz*

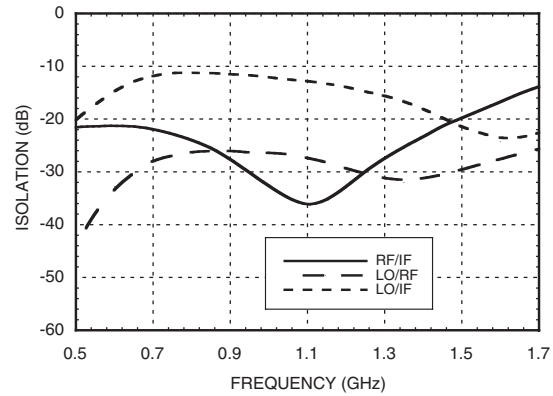
Parameter	Min.	Typ.	Max.	Units
Frequency Range, RF & LO	0.7 - 1.2			GHz
Frequency Range, IF	DC - 0.3			GHz
Conversion Loss		9	10.5	dB
Noise Figure (SSB)		9	10.5	dB
LO to RF Isolation	20	26		dB
LO to IF Isolation	8	12		dB
IP3 (Input)	17	21		dBm
1 dB Compression (Input)	9	12		dBm

*Unless otherwise noted, all measurements performed as a downconverter with low side LO.

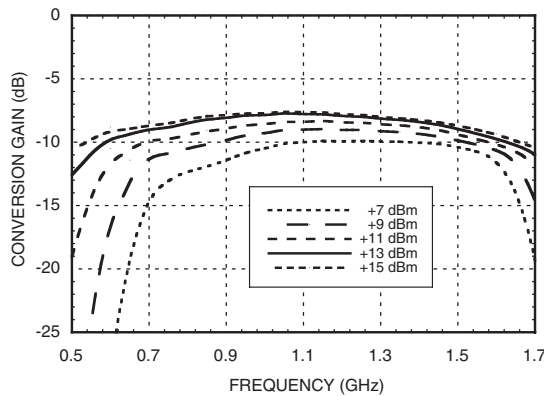
**Conversion Gain vs.
Temperature @ LO = +13 dBm**



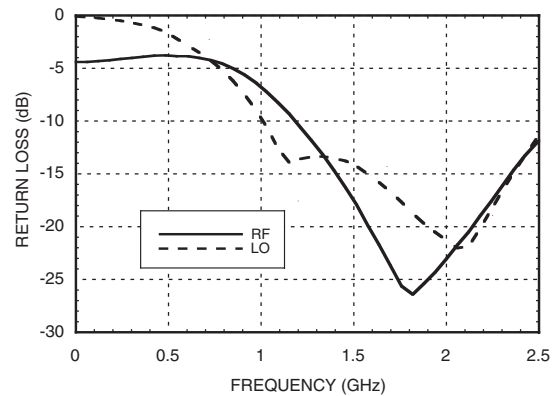
Isolation @ LO = +13 dBm



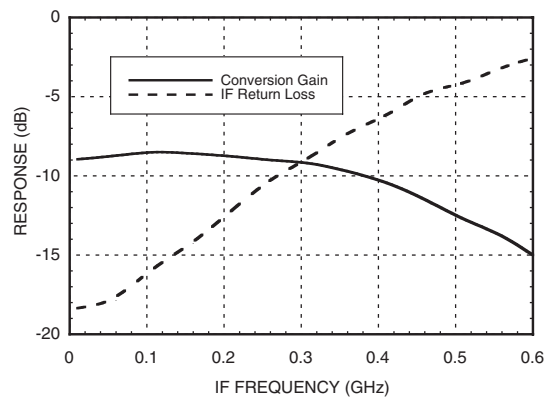
Conversion Gain vs. LO Drive



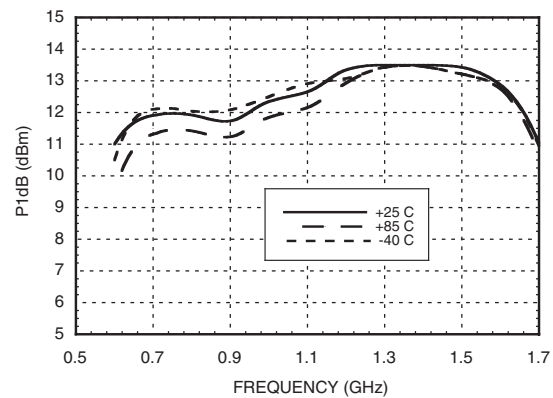
Return Loss @ LO = +13 dBm



**IF Bandwidth &
IF Return Loss @ LO = +13 dBm**

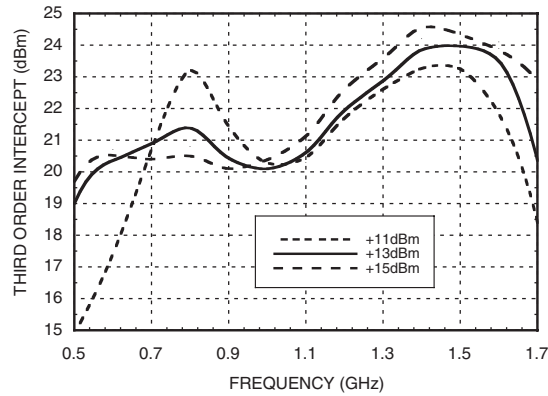


P1dB vs. Temperature @ LO = +13 dBm

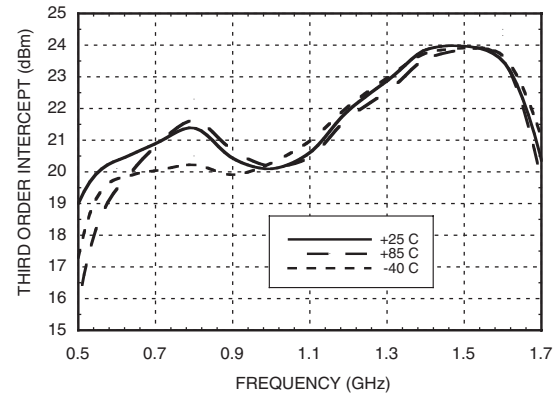


GaAs MMIC SMT SINGLE BALANCED MIXER, 0.7 - 1.2 GHz

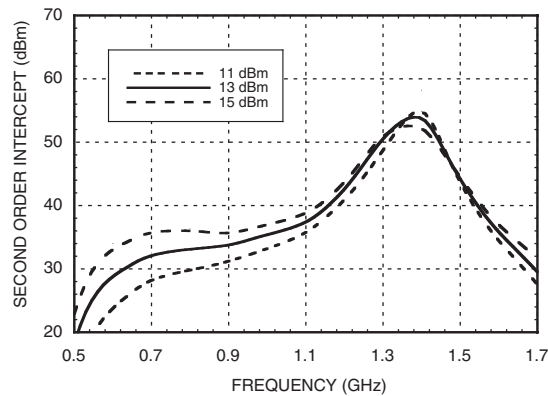
Input IP3 vs. LO Drive



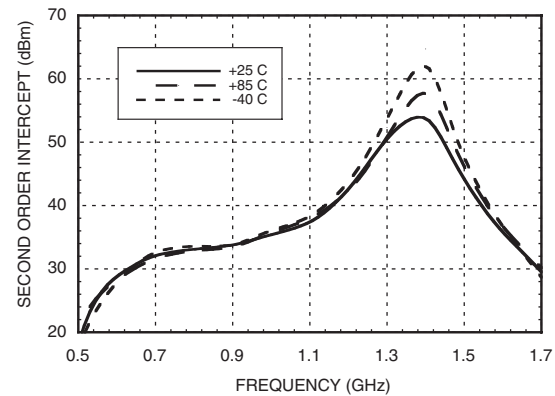
Input IP3 vs. Temperature @ LO = +13 dBm



Input IP2 vs. LO Drive



Input IP2 vs. Temperature @ LO = +13 dBm



MxN Spurious Outputs

mRF	nLO				
	0	1	2	3	4
0	xx	-15	4	25	19
1	19	0	36	38	36
2	44	49	52	40	63
3	69	83	87	62	74
4	95	90	90	93	78

RF = 0.96 GHz @ -5 dBm
LO = 0.8 GHz @ +13 dBm
All values in dBc relative to the IF

Harmonics of LO

LO Frequency (GHz)	nLO Spur at RF Port			
	1	2	3	4
0.5	31	19	56	35
0.7	26	14	46	40
0.9	26	14	49	40
1.1	29	20	48	39
1.3	31	25	49	39
1.5	27	29	58	42

LO = +13 dBm
Values in dBc below input LO level measured at the RF port.

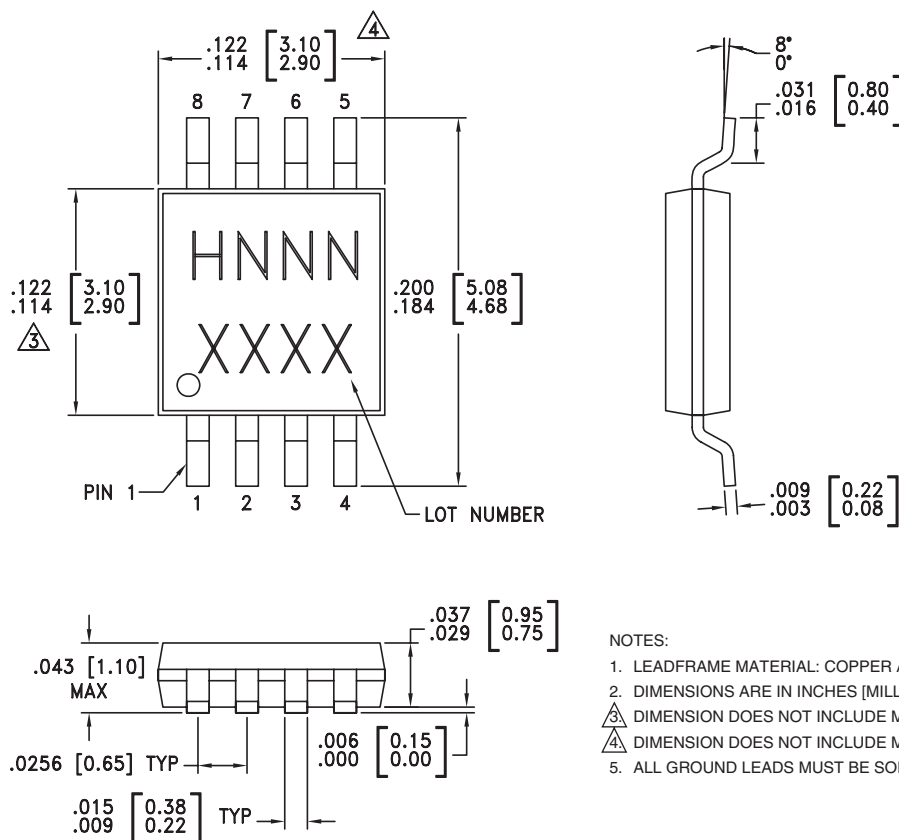
Absolute Maximum Ratings

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



Package Information


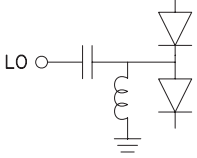
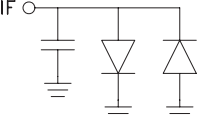
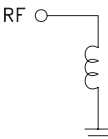
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC277MS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H277 XXXX
HMC277MS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	<u>H277</u> XXXX

[1] Max peak reflow temperature of 235 °C

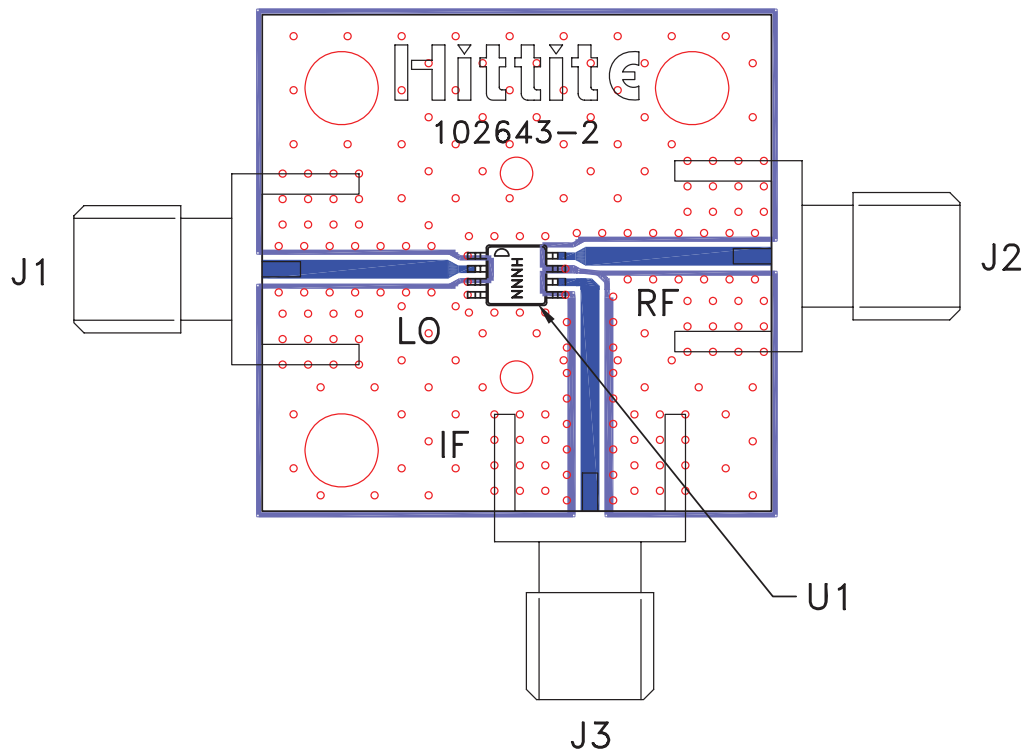
[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 5	GND	This pin must be connected to RF ground.	
2	LO	This pin is AC coupled & matched to 50 Ohms from 0.7 to 1.2 GHz.	
4, 7	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
6	IF	This pin is DC coupled. For applications not requiring operation to DC this port should be DC blocked externally using a series capacitor. Choose value of capacitor to pass IF frequency desired. For operation to DC, this pin must not sink/source more than 40 mA of current or failure may result.	
8	RF	This pin is DC coupled & matched to 50 Ohms from 0.7 to 1.2 GHz	

Evaluation Circuit Board



List of Materials for Evaluation PCB 115791 ^[1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC277MS8 / HMC272MS8E Mixer
PCB ^[2]	102643 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.